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RD Number: RD191

RD Title: FET(TPN11003NL) board BOM for motor pre-driver IC board

| Item No. | Designator | Quantity | Value          | Part Number | Manufacturer | Description                             | Package      | Not Mount |
|----------|------------|----------|----------------|-------------|--------------|---|--------------|-----------|
| 1        | FET        | 6        | TPN11003NL     | TPN11003NL  | TOSHIBA      | MOSFET                                  | TSON Advance |           |
| 2        | CON        | 1        | Pin header 16P | —           | —            | Board to board right angle 16pin header |              |           |

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